3719-1 4.5" x 6.5"

Circuit Pattern: Contacts Only Contacts: 36/72 @ .100" Ctrs,

Ni/Gold
Width/Thick: 6.50"/.062"
Height: 4.50"
16-Pin DIP Capacity: 50

 Material:
 CEM-1

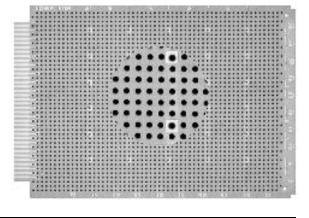
 Wire-Wrap Terminals:
 T44, T46, T49, T68

Wire-Wrap Socket Pins: R32
Solder Connector: R636-2
Extender: 3690-4
Rec. Card Cage: Series 13
Wire-Wrap Connector: R636-1

 Unrestricted component placement over entire board surface

 Layout paper and instructions included

 Row and column legends provided



3719-6

Hole Diameter:

4.5" x 6.5"

.042"

Circuit Pattern: Pad-Per-Hole
Contacts: 9a6/72 @ .100" Ctrs,
Ni/Gold

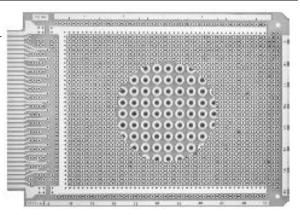
Ni/Gold
Width/Thick: 6.50"/.062"
Height: 4.50"
16-Pin DIP Capacity: 40

16-Pin DIP Capacity:
Material:

Material:FR4 Epoxy GlassWire-Wrap Terminals:T44, T46, T49, T68Wire-Wrap Socket Pins:R32

Solder Connector: R636-2 Extender: 3690-4 Rec. Card Cage: Series 13 Wire-Wrap Connector: R644-1 Hole Diameter: .042" 0.080" diameter, isolated solder
 pad around holes, plated-thru
 holes

- Low resistance, etched peripheral bus pattern
- Pad and bus surfaces soldercoated for user convenience
- Convenient, easy-to-read hole marking legend on board surface
- Layout paper and instructions included



4066-4

4.5" x

Circuit Pattern: Ground Plane/ Interleaved Buses Contacts: 36/72 @ .100" Ctrs,

Ni/Gold
Width/Thick: 6.50"/.062"
Height: 4.50"

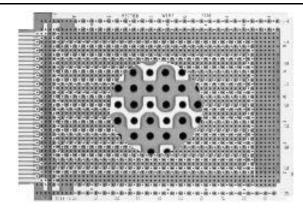
16-Pin DIP Canacity: 34

16-Pin DIP Capacity: 34
Material: CEM-1

Wire-Wrap Terminals: T44, T46, T49, T68
Wire-Wrap Socket Pins: R32
Solder Connector: R636-2

Extender: 3690-4
Rec. Card Cage: Series 13
Wire-Wrap Connector: R636-1
Hole Diameter: .042"

- Overall ground plane on wiring side; etched, interleaved zig-zag bus pattern on component side provides three bus lines for ECL circuitry
- 0.085" etched clearance area around each hole on ground plane side
- Bus and plane surfaces soldercoated for user convenience
- Layout paper and instructions included



3719-4

4.5" x 9.6"

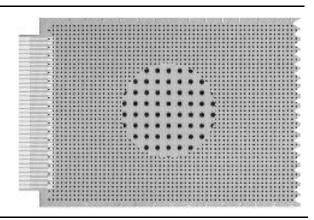
Circuit Pattern: Contacts Only Contacts: 36/72 @ .100" Ctrs,

Ni/Gold
Width/Thick: 9.60"/0.62"
Height: 4.50"
16-Pin DIP Capacity: 90

Material: CEM-1 Wire-Wrap Terminals: T44, T46, T49, T68

Wire-Wrap Terminals: T44, T46, T4
Wire-Wrap Socket Pins: R32
Solder Connector: R636-2
Extender: 3690-2
Rec. Card Cage: Series 14
Wire-Wrap Connector: R636-1
Hole Diameter: .042"

- Unrestricted component placement over entire board surface
- Row and column legends
 provided
- Layout paper and instructions included





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<u>3719-1</u> <u>3719-6</u> <u>3719-4</u>